VAOL-S8RP4

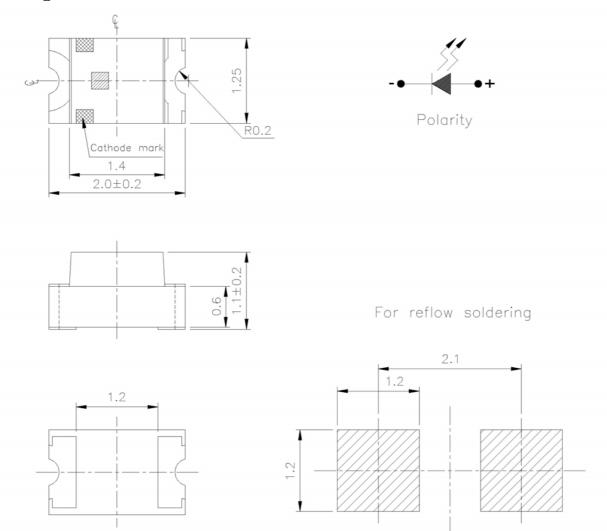
#### **Features**

- Fit automatic placement equipment.
- Fit Compatible with infrared and vapor phase reflow solder process.
- Pb-free.
- RoHS compliant.

## **Descriptions**

- For higher packing density .
- For minature applications.
- Water clear lens .
- Chip material : AlGaInP.
- Emitting color: Red.

## **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm







# Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	Vr	5	V
Forward Current	IF	25	mA
Operating Temperature	Topr	<b>-</b> 40 ∼ +85	°C
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathrm{C}$
Electrostatic Discharge	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	60	mA
Soldering Temperature	Tsol	Reflow Soldering: 260 Hand Soldering: 350	

# Electro-Optical Characteristics (Ta=25°C)

			<u> </u>				
Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	A2	15	38		mcd	J. 20. A
		A3	40	60			
		A4	50	75			
		A5	60	90			
		A6	85	123			
Viewing Angle	2 \theta 1/2			140		deg	I <sub>F</sub> =20 mA
Peak Wavelength	λp			632		nm	
Dominant Wavelength	λd			624		nm	
Spectrum Radiation Bandwidth	Δλ			20		nm	
Forward Voltage	VF			2.0	2.4	V	
Reverse Current	Ir				10	μΑ	V <sub>R</sub> =5V

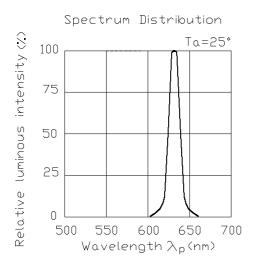
Specific binning requirements- please contact our home office

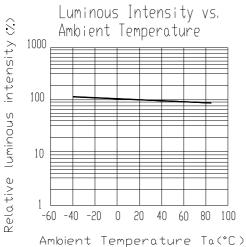


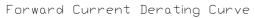


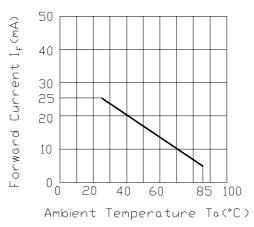


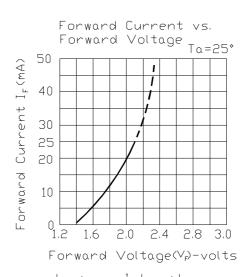
## **Typical Electro-Optical Characteristics Curves**

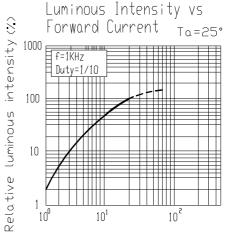


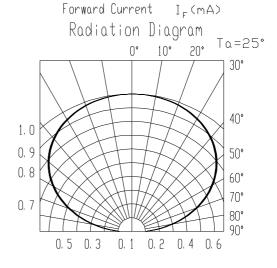








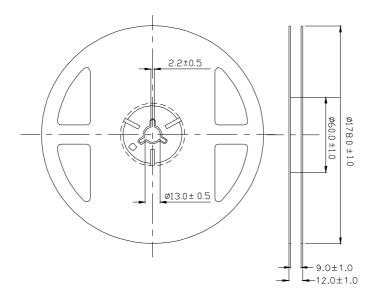








#### **Reel Dimensions**

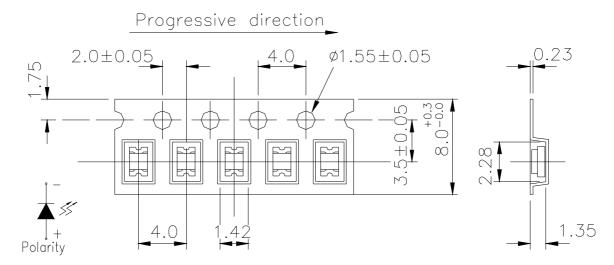


**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm



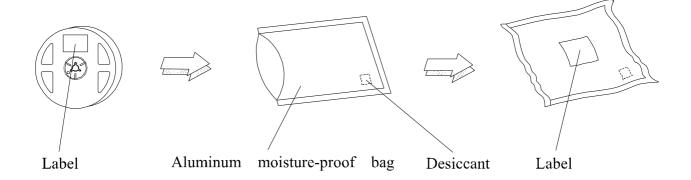


# Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

# Moisture Resistant Packaging

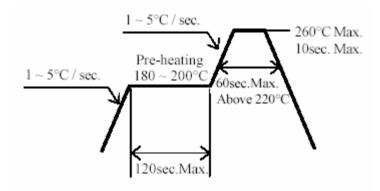






#### **Soldering Condition**

1.Pb-free solder temperature profile



- 2.Reflow soldering should not be done more than two times.
- 3 When soldering, do not put stress on the LEDs during heating.
- 4 After soldering, do not warp the circuit board.

#### Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.





# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

VCC: VAOL-S8RP4